TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74HC174AP,TC74HC174AF

Hex D-Type Flip Flop with Clear

The TC74HC174A is a high speed CMOS D-TYPE FLIP FLOP fabricated with silicon gate C²MOS technology.

It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

Information signals applied to the D inputs are transferred to the Q outputs on the positive going edge of the clock pulse.

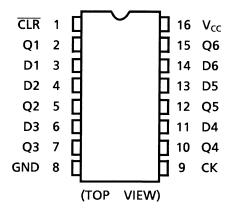
When the $\overline{\text{CLR}}$ input is held low, the Q outputs are in the low logic level independent of the other inputs.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

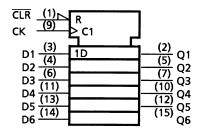
Features

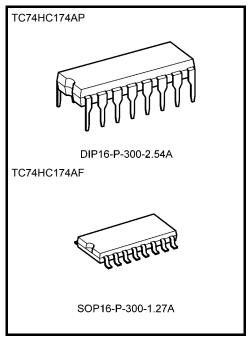
- High speed: $f_{max} = 71 \text{ MHz}$ (typ.) at $V_{CC} = 5 \text{ V}$
- Low power dissipation: $I_{CC} = 4 \mu A \text{ (max)}$ at $T_{a} = 25 \text{°C}$
- High noise immunity: $V_{NIH} = V_{NIL} = 28\% V_{CC}$ (min)
- Symmetrical output impedance: | I_{OH} | = I_{OL} = 4 mA (min)
- Balanced propagation delays: $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range: V_{CC} (opr) = 2~6 V
- Pin and function compatible with 74LS174

Pin Assignment



IEC Logic Symbol





Weight

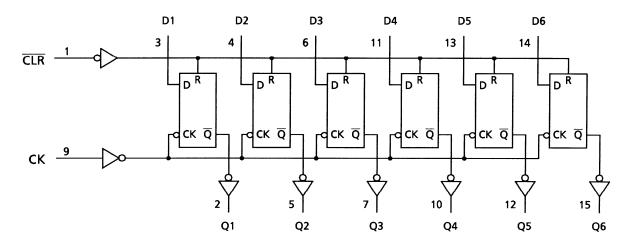
DIP16-P-300-2.54A : 1.00 g (typ.) SOP16-P-300-1.27A : 0.18 g (typ.)

Truth Table

	Inputs		Output	Function
CLR	D	CK	Q	Tunction
L	Х	Х	L	Clear
Н	L		L	_
Н	Н		Н	_
Н	Х	\neg	Qn	No Change

X: Don't care

System Diagram



Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V _{CC}	-0.5~7	V
DC input voltage	V _{IN}	-0.5~V _{CC} + 0.5	V
DC output voltage	V _{OUT}	-0.5~V _{CC} + 0.5	V
Input diode current	I _{IK}	±20	mA
Output diode current	lok	±20	mA
DC output current	lout	±25	mA
DC V _{CC} /ground current	Icc	±50	mA
Power dissipation	PD	500 (DIP) (Note 2)/180 (SOP)	mW
Storage temperature	T _{stg}	−65~150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to $65^{\circ}C$. From Ta = 65 to $85^{\circ}C$ a derating factor of -10 mW/°C shall be applied until 300 mW.



Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V _{CC}	2~6	V
Input voltage	V _{IN}	0~V _{CC}	٧
Output voltage	V _{OUT}	0~V _{CC}	٧
Operating temperature	T _{opr}	-40~85	°C
		0~1000 (V _{CC} = 2.0 V)	
Input rise and fall time	t _r , t _f	0~500 (V _{CC} = 4.5 V)	ns
		0~400 (V _{CC} = 6.0 V)	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

Electrical Characteristics

DC Characteristics

Characteristics	Courselle al	Test Condition $V_{CC}\left(V\right)$		Ta = 25°C			Ta = -40~85°C		Unit	
Characteristics	Symbol			V _{CC} (V)	Min	Тур.	Max	Min	Max	Offic
		_		2.0	1.50	_	_	1.50	_	
High-level input voltage	V_{IH}			4.5	3.15	_	_	3.15	_	V
Ŭ				6.0	4.20	_	_	4.20		
				2.0	_	_	0.50	_	0.50	
Low-level input voltage	V_{IL}		_		_	_	1.35	_	1.35	V
				6.0	_	_	1.80	_	1.80	
	Vон	V _{IN} = V _{IH} or V _{IL}		2.0	1.9	2.0	_	1.9	_	
			$I_{OH} = -20 \mu A$	4.5	4.4	4.5	_	4.4	_	
High-level output voltage				6.0	5.9	6.0	_	5.9	_	V
			$I_{OH} = -4 \text{ mA}$	4.5	4.18	4.31	_	4.13	_	
			$I_{OH} = -5.2 \text{ mA}$	6.0	5.68	5.80	_	5.63		
				2.0	_	0.0	0.1	_	0.1	
			$I_{OL} = 20 \mu A$	4.5	_	0.0	0.1	_	0.1	
Low-level output voltage	V_{OL}	V _{IN} = V _{IH} or V _{IL}		6.0	_	0.0	0.1	_	0.1	V
			I _{OL} = 4 mA	4.5	_	0.17	0.26	_	0.33	
			I _{OL} = 5.2 mA	6.0	_	0.18	0.26	_	0.33	
Input leakage current	I _{IN}	V _{IN} = V _{CC} or GND		6.0		_	±0.1	_	±1.0	μΑ
Quiescent supply current	Icc	V _{IN} = V _{CC} or	GND	6.0	_	_	4.0	_	40.0	μА



Timing Requirements (input: $t_r = t_f = 6 \text{ ns}$)

Characteristics	Symbol Test Condition			Ta = 25°C		Ta = -40 ~85°C	Unit
			V _{CC} (V)	Тур.	Limit	Limit	
Minimum pulse width	to a s		2.0	_	75	95	
(CK)	tw (L)	_	4.5	_	15	19	ns
(CK)	t _{W (H)}		6.0		13	16	
Minimum pulse width			2.0	_	75	95	
(CLR)	t _{W (L)}	_	4.5	_	15	19	ns
(GLK)			6.0		13	16	
	t _s	_	2.0	_	75	95	
Minimum set-up time			4.5	_	15	19	ns
			6.0		13	16	
	t _h		2.0	_	0	0	ns
Minimum hold time		_	4.5	_	0	0	
			6.0		0	0	
Minimum removal time			2.0	_	25	30	
(CLR)	t _{rem}	_	4.5	_	5	6	ns
(OLIV)			6.0		4	5	
			2.0	_	6	4	
Clock frequency	f	_	4.5	_	33	26	MHz
			6.0	_	38	30	

AC Characteristics (C_L = 15 pF, V_{CC} = 5 V, Ta = 25°C, input: $t_r = t_f = 6$ ns)

Characteristics Syr		Test Condition	Min	Тур.	Max	Unit
Output transition time	t _{TLH} t _{THL}	_	_	4	8	ns
Propagation delay time (CK-Q)	t _{pLH}	_	_	14	26	ns
Propagation delay time (CLR -Q)	t _{pHL}	_	_	15	26	ns
Maximum clock frequency	f _{max}	_	39	71	_	MHz



AC Characteristics ($C_L = 50$ pF, input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition		-	Ta = 25°C		Ta = -40~85°C		Unit
Characteristics	Symbol		V _{CC} (V)	Min	Тур.	Max	Min	Max	5
	4		2.0	_	27	75	_	95	
Output transition time	t _{TLH}	_	4.5	_	8	15	_	19	ns
	t _{THL}		6.0	_	7	13	_	16	
Propagation delay	+		2.0	_	68	150	_	190	
time	t _{pLH}	_	4.5	_	17	30	_	38	ns
(CK-Q)	t _{pHL}		6.0	_	14	26	_	32	
Propagation delay			2.0	_	72	150	_	190	
time	t_{pHL}	_	4.5	_	18	30	_	38	ns
(CLR -Q)			6.0	_	15	26	_	32	
			2.0	6	15	_	4	_	
Maximum clock frequency	f _{max}	_	4.5	33	59	_	26	_	MHz
,			6.0	38	71	_	30	_	
Input capacitance	C _{IN}				5	10	_	10	pF
Power dissipation	C_{PD}				40				nΕ
capacitance	(Note)	_			40				pF

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

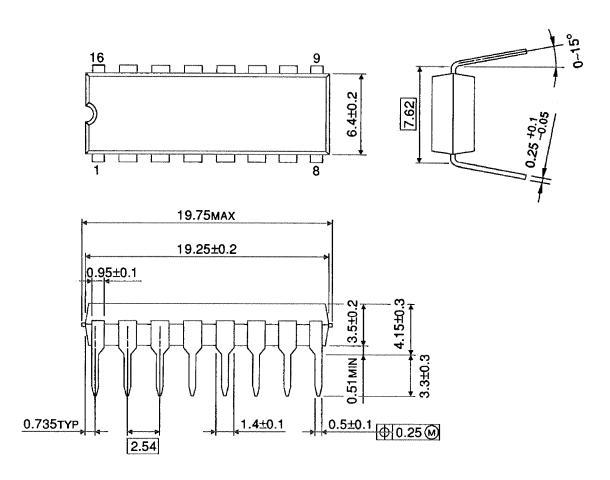
$$I_{CC}$$
 (opr) = $C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/6$ (per flip flop)

And the total CPD when n pcs. of Flip Flop operate can be gained by the following equation:

$$C_{PD}$$
 (total) = 28 + 12 · n

Package Dimensions

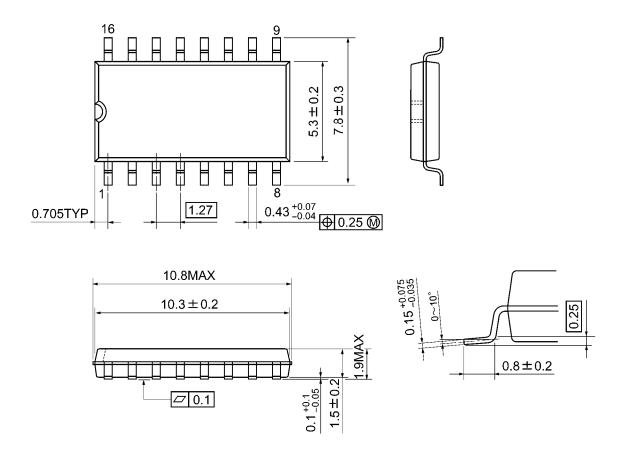
DIP16-P-300-2.54A Unit: mm



Weight: 1.00 g (typ.)

Package Dimensions

SOP16-P-300-1.27A Unit: mm



Weight: 0.18 g (typ.)

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